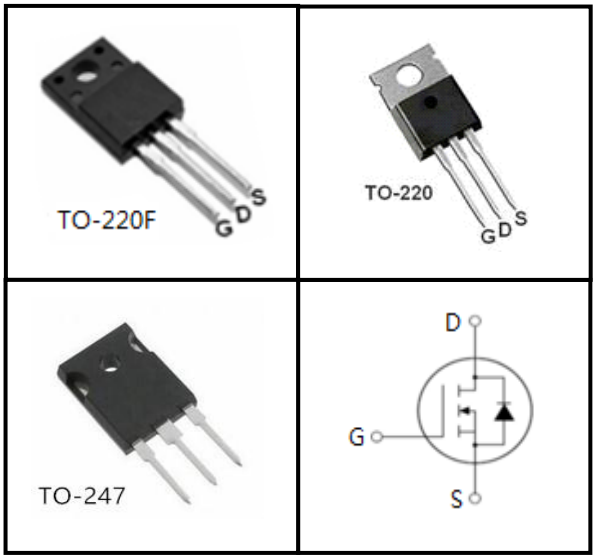
650V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information

Device	Package	Marking
CS16N65F	TO-220F	CS16N65F
CS16N65P	TO-220	CS16N65P
CS16N65W	TO-247	CS16N65W

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted

Parameter	Symbol	Value			Unit
		TO-220F	TO-220	TO-247	
Drain-Source Voltage (V_{GS} = 0V)	V_{DSS}	650			V
Continuous Drain Current	I_D	16			A
Pulsed Drain Current (note1)	I_{DM}	64			A
Gate-Source Voltage	V_{GSS}	±30			V
Single Pulse Avalanche Energy (note2)	E_{AS}	460			mJ
Avalanche Current (note1)	I_{AS}	9.6			A
Repetitive Avalanche Energy (note1)	E_{AR}	276			mJ
Power Dissipation (T_C = 25ºC)	P_D	98	196		W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150			ºC

Thermal Resistance

Parameter	Symbol	Value			Unit
		TO-220F	TO-220	TO-247	
Thermal Resistance, Junction-to-Case	R_{thJC}	1.27	0.635		ºC/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	60		

Specifications T_J = 25ºC, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Value**			**Unit**
			Min.	**Typ.**	**Max.**	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	650	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 650V, V_{GS} = 0V, T_J = 25ºC	--	--	1	μA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	3.0	--	4.0	V
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	V_{GS} = 10V, I_D = 8A	--	0.45	0.55	Ω
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz	--	2063	--	pF
Output Capacitance	C_{oss}		--	204	--	
Reverse Transfer Capacitance	C_{rss}		--	29	--	
Total Gate Charge	Q_g	V_{DD} = 520V, I_D = 16A, V_{GS} = 10V	--	74	--	nC
Gate-Source Charge	Q_{gs}		--	10	--	
Gate-Drain Charge	Q_{gd}		--	40	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 325V, I_D =16A, R_G = 25 Ω	--	54	--	ns
Turn-on Rise Time	t_r		--	40	--	
Turn-off Delay Time	$t_{d(off)}$		--	312	--	
Turn-off Fall Time	t_f		--	66	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25 ºC	--	--	16	A
Pulsed Diode Forward Current	I_{SM}		--	--	64	
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} = 8A, V_{GS} = 0V	--	--	1.4	V
Reverse Recovery Time	t_{rr}	V_{GS} = 0V,I_S = 16A, di_F/dt =100A /μs	--	682	--	ns
Reverse Recovery Charge	Q_{rr}		--	4.5	--	μC

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L=10mH, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25 ºC
3. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%

Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics (T_J = 25ºC)

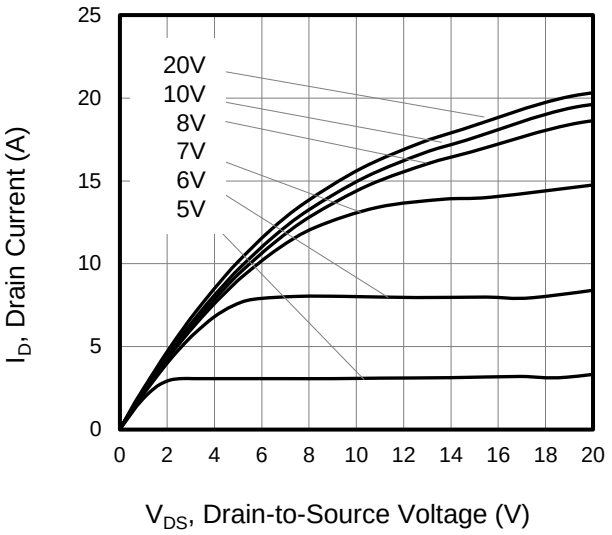


Figure 2. Body Diode Forward Voltage

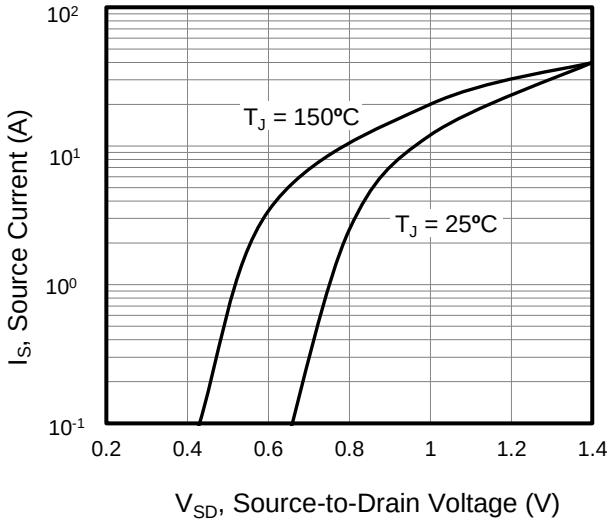


Figure 3. Drain Current vs. Temperature

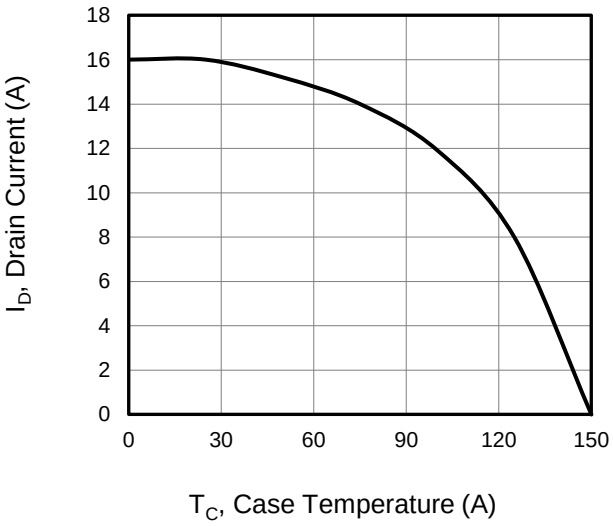


Figure 4. BV_{DSS} Variation vs. Temperature

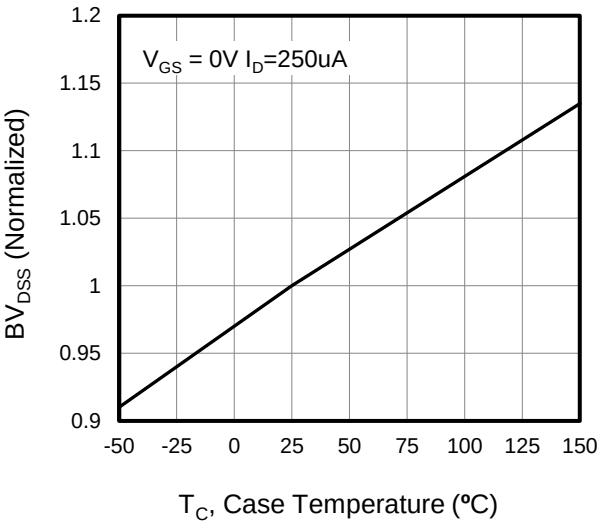


Figure 5. Transfer Characteristics

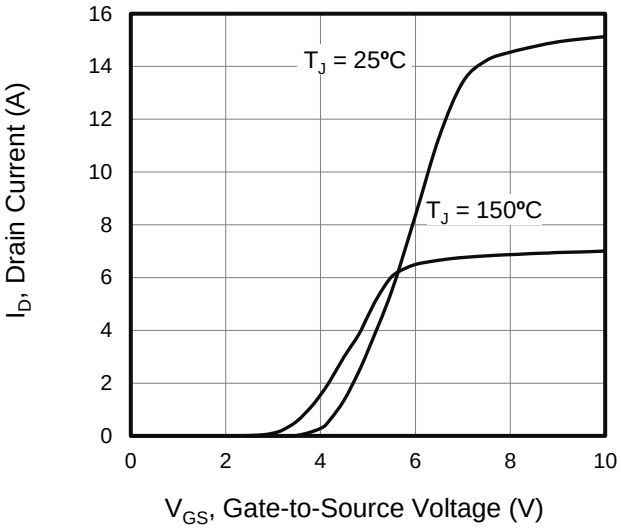
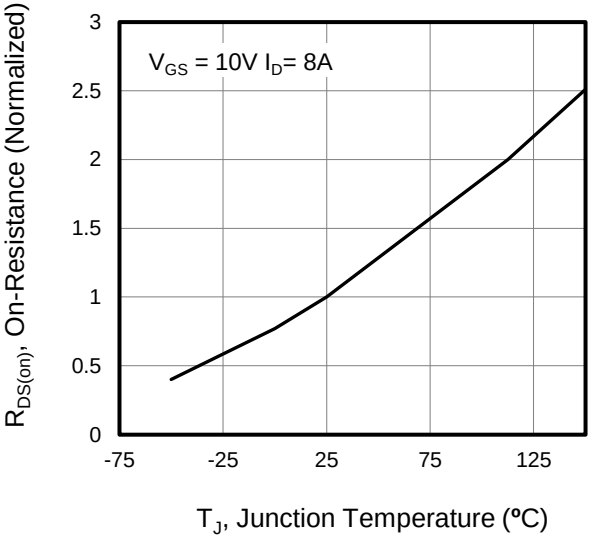


Figure 6. On-Resistance vs. Temperature



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Capacitance

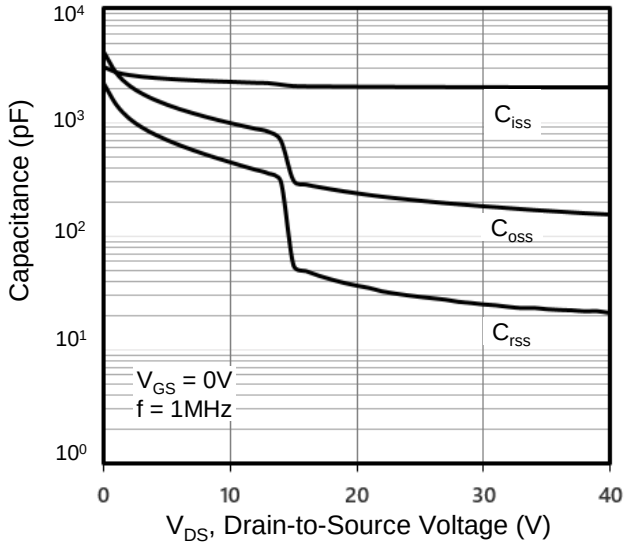


Figure 8. Gate Charge

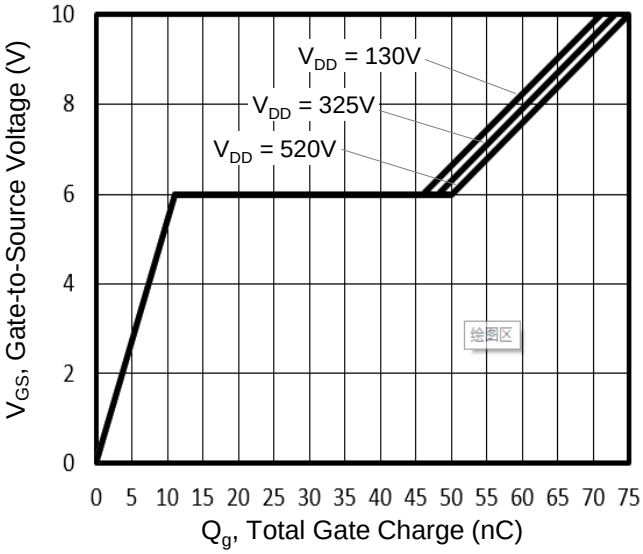


Figure 9. Transient Thermal Impedance

TO-220F

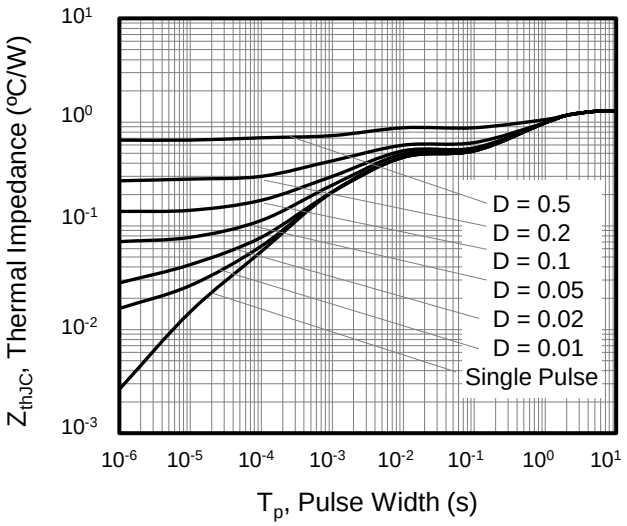


Figure 10. Transient Thermal Impedance

TO-220

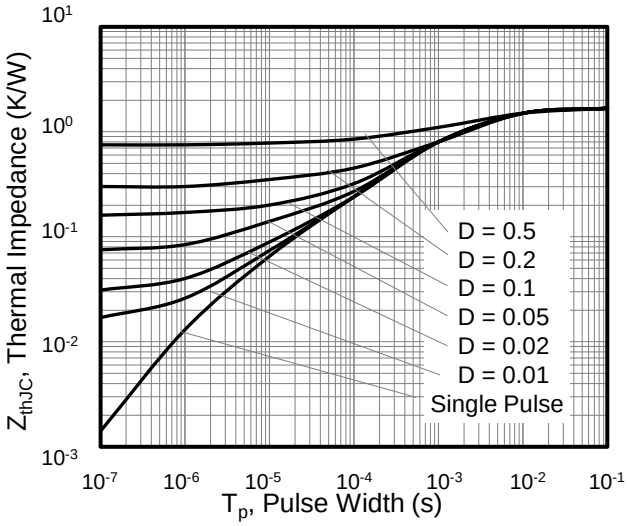


Figure A：Gate Charge Test Circuit and Waveform

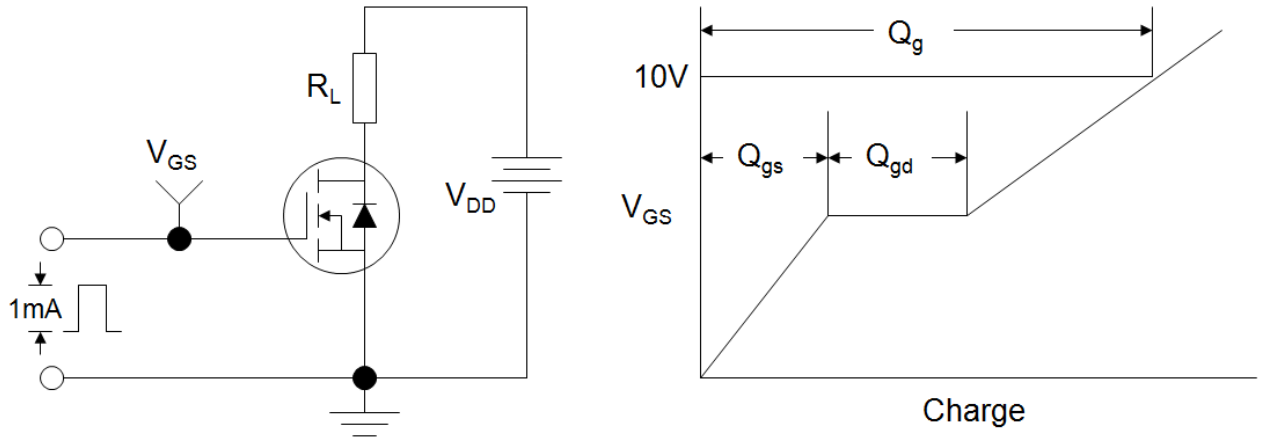


Figure B：Resistive Switching Test Circuit and Waveform

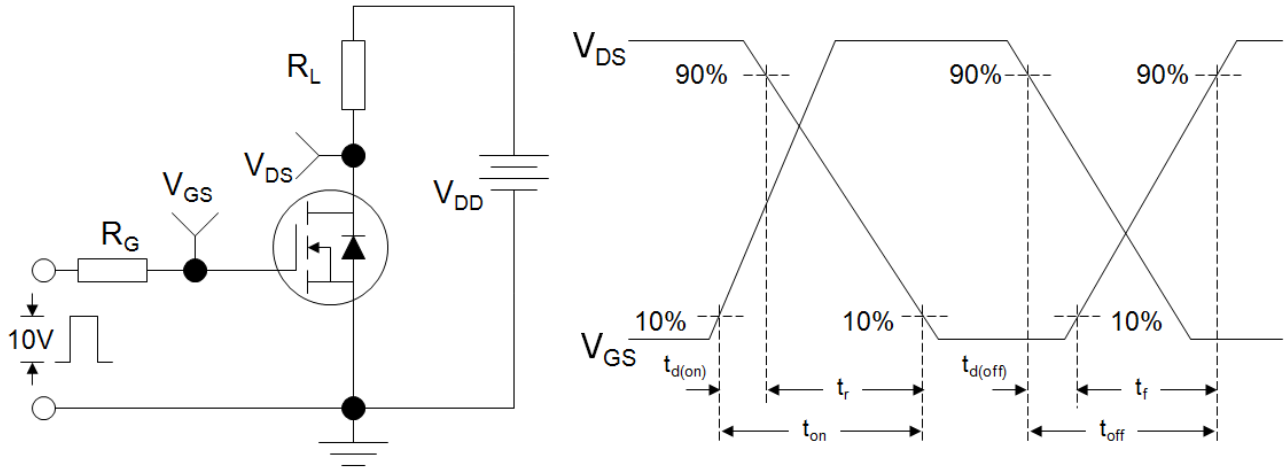
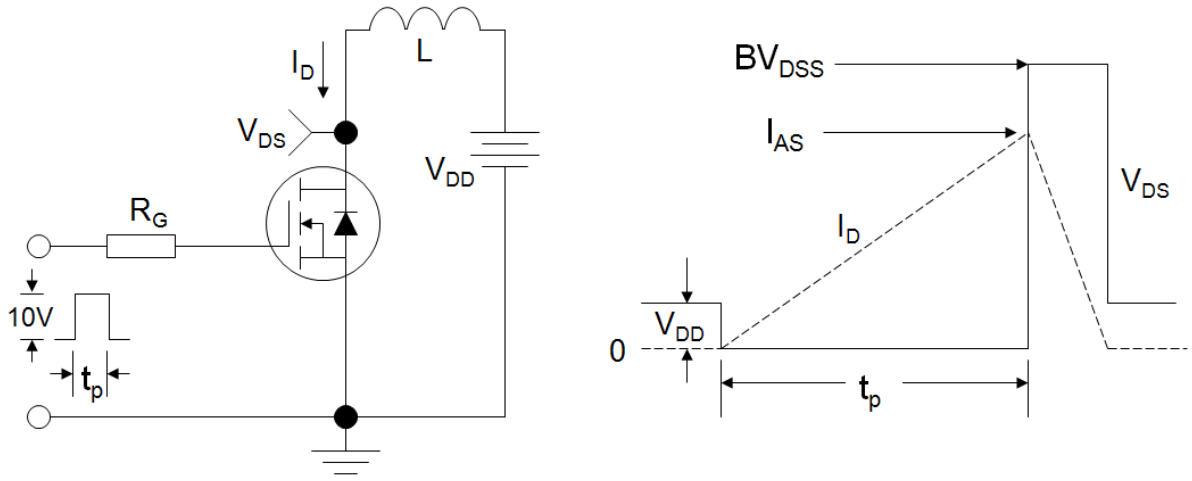
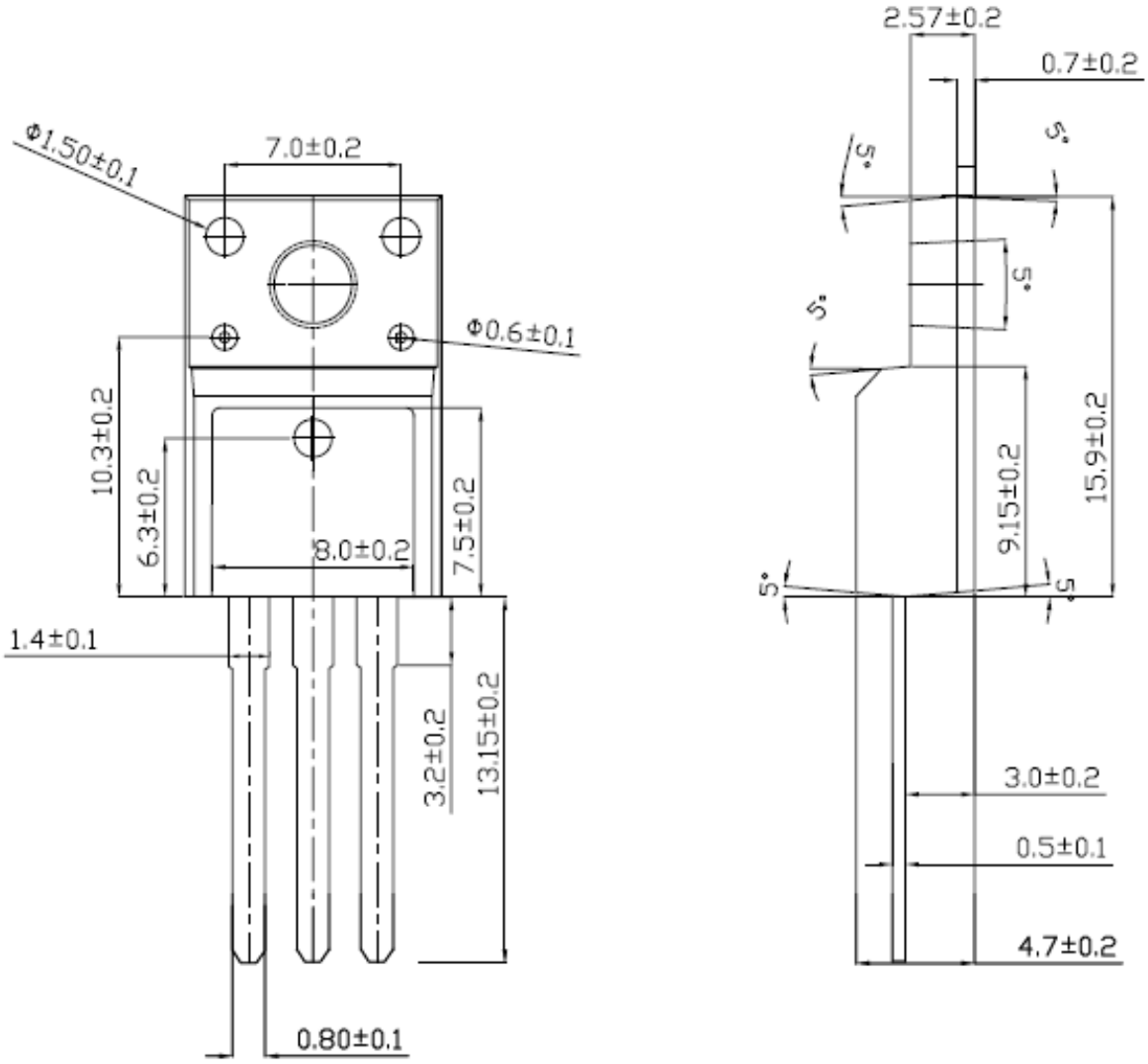


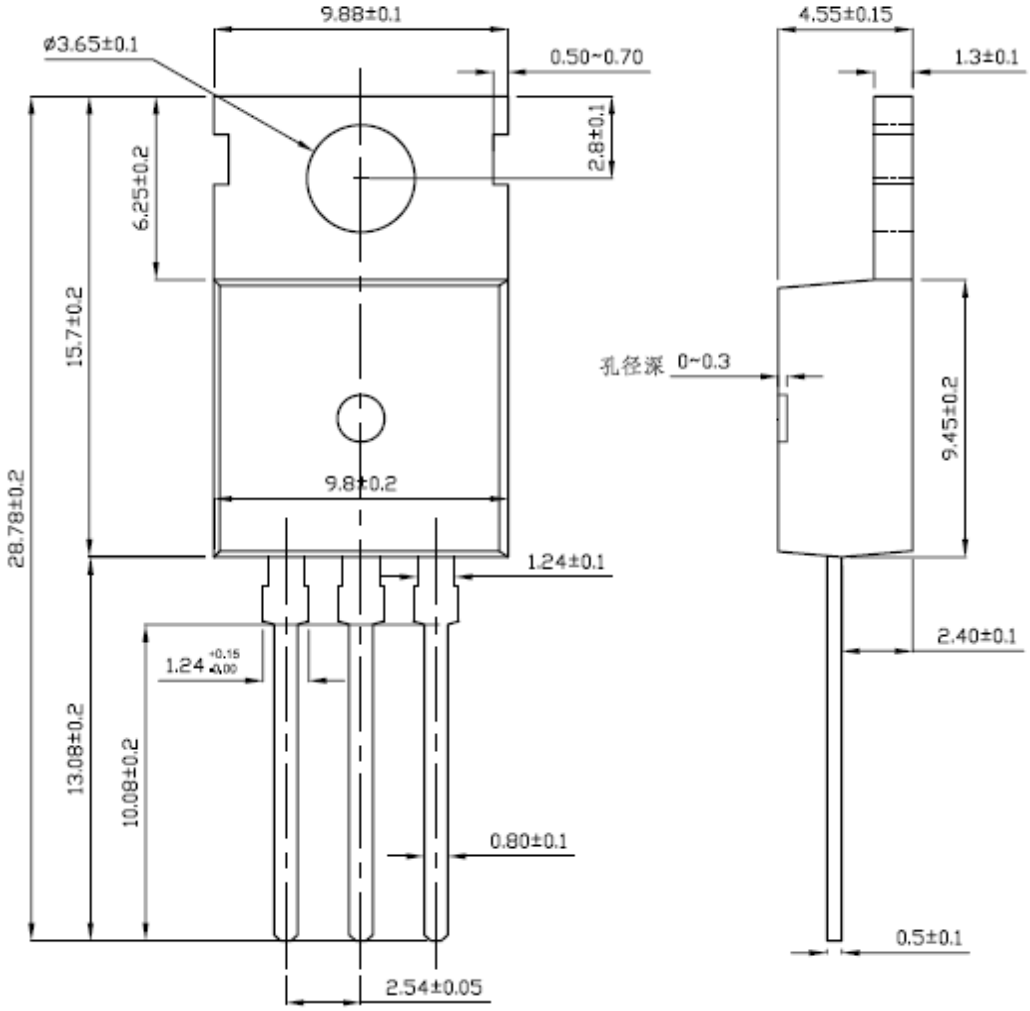
Figure C：Unclamped Inductive Switching Test Circuit and Waveform



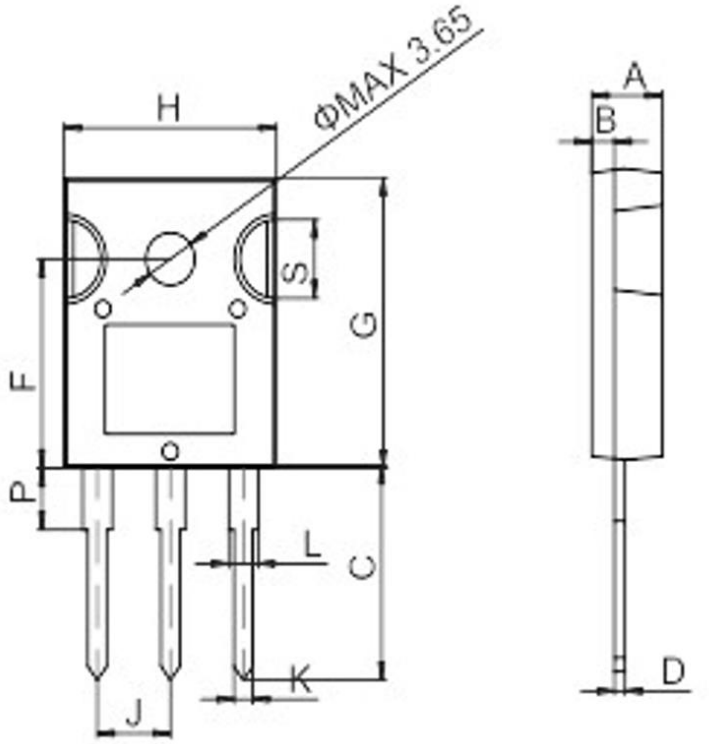
TO-220F


Φ1.50±0.1
7.0±0.2
Φ0.6±0.1
10.3±0.2
6.3±0.2
8.0±0.2
7.5±0.2
1.4±0.1
3.2±0.2
13.15±0.2
0.80±0.1
2.57±0.2
0.7±0.2
5°
5°
5°
5°
5°
5°
15.9±0.2
9.15±0.2
3.0±0.2
0.5±0.1
4.7±0.2

TO-220


9.88±0.1
ø3.65±0.1
0.50~0.70
2.8±0.1
6.25±0.2
15.7±0.2
28.78±0.2
9.8±0.2
1.24±0.1
1.24 +0.15 -0.00
13.08±0.2
10.08±0.2
0.80±0.1
2.54±0.05
4.55±0.15
1.3±0.1
孔径深 0~0.3
9.45±0.2
2.40±0.1
0.5±0.1

TO-247



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.9		5.4	0.193		0.213
B	1.6		2.0	0.063		0.079
C	14.35		15.4	0.565		0.606
D	0.5		0.8	0.020		0.031
F	14.4		15.1	0.567		0.594
G	19.7		20.6	0.775		0.811
H	15.4		16.2	0.606		0.638
J	5.3		5.6	0.209		0.220
K	1.3		1.5	0.051		0.059
L	2.8		3.3	0.110		0.130
P	3.7		4.2	0.146		0.165
S	5.35		5.65	0.211		0.222

Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Suzhou Convert does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Suzhou Convert.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless. Customers using or selling Suzhou Convert products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Suzhou Convert for any damages arising or resulting from such use or sale.

Suzhou Convert disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Suzhou Convert's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Suzhou Convert SemiConductor CO., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Suzhou Convert products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Suzhou Convert believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.